

and was amended on _

ATTURNEY DOCKET N . 0756-978

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named below)

of the invention entitled: * INSULATEING FILM AND METHOD OF PRODUCING SEMICONDUCTOR DEVICE , the specification of which is attached hereto unless the following box is checked: I The specification was filed on Feb. and was assigned Serial No. 08/198,

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Country

(Application Serial No.)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I do not know and do not believe the same was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof, or more than one year prior to this application, that the same was not in public use or on sale in the United States of America more than one year prior to this application, that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months prior to this application, and that no application for patent or inventor's certificate on this invention has been filed in any country foreign t the United States of America prior to this application by me or my legal representatives or assigns, except as follows:

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and checked at right: Priority Claimed

I	rior Foreign Application(s)			,	
	5-55236	JAPAN (Country)	Feb. 19, 1993	- X	□ א•
, ic)	(Number)	(Country)	(Month/Day/Year Filed)	- C	N°
	(Number)	(Country)	(Month/Cay/Year Filed)	- Yes	□ N•
•	(Number)		(Month/Day/Year Filed)	_	□ 80
	(Number)	(Country)	(Month/Day/Year Filed)	_ 📮	N• □
	(Number) All Foreign Applications,	if any, for any Patent or Inv	ventor's Certificate Filed More	Than 12 I	Mondi

S Prior To The Filing Date of This Application: Date of Filing (Month/Day/Year) Application No.

I hereby claim the benefit und application(s) listed below and, insoft not disclosed in the prior United State 35, United States Code, §112, I acknowledge of Federal Regulations, §1.5 and the national or PCT international	ar as the subject matter of each es application in the mainer proposited the duty to disclose mate (66), which occurred between the	erial information as defined in Title
(Application Serial No.)	(l'iling Date)	(Status - patentral, pending, abandoned)

(Pilling Date)

(Surus -priental, pending, shandonal)

I hereby appoint the following attorneys to prosecute this application and/or an international application and to transact all business in the Patent and Trademark Office connected therewith:

Daniel W. Sixbey (Reg. No. 20,932) Stuart J. Friedman (Reg. N . 24,312) Charles M. Leedom, Jr. (Reg. No. 26,477) Cerald J. Ferguson, Jr. (Reg. No. 23,016) David S. Safran (Reg. No. 27,997) Thomas W. C le (Reg. No. 28,290)

Send Correspondence to:

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Insen Name of Non-U.S.

Ų I SDBEY, FRIEDMAN, LEEDOM & FERGUSON, P.C. 2010 Corporate Ridge, Suite 600 McLean, Virginia 22102 Telephone: (703) 790-9110

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

The undersigned hereby authorize any U.S. attorney or agent named herein to accept and follow instructions from. as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney or agent and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys or agents named herein will be so notified by the undersigned.

1, 222,	igents named herein will be so notified by the	e undersigned.				
Insert Full Wirns of Furst or Sole Leventor and Date This	FULL NAME OF SOLE OR FIRST INVENTOR Shunpei YAMAZAKI	INVENTOR'S SIGNATURE	hi	DATE 4/8/1994		
Deciment EsSiened	RESIDENCE (City, State & Country)		CITIZENSHIP			
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			agawa-ken .	DATE		
Third Inventor:	FULL NAME OF THIRD JOINT INVENTOR, IF ANY	INVENTOR'S SIGNATURE		4/7/1994		
sec above		Malinati)ek	رکساز CITIZENSHIP	4/ // 1374		
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	Yukiko UEHARA	Yukiko Veho		4/6/1994		
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INVENTOR'S SIGNATURE DATE FAMILY NAME Full Name of Fifth GIVEN NAME 4/8/1994 Hiroshi UEHARA hwersor, if any: CITIZENSHIP RESIDENCE (City, State & Country) Japanese Kanagawa, Japan POST OFFICE ADDRESS (Complete Street Address including City, State & Country) Flat Atsugi 207, 931-1, Hase, Atsugi-shi, Kanagawa-ken 243 Japan DATE INVENTOR'S SIGNATURE FAMILY NAME GIVEN NAME Full Name of Sixth Inventor, if my CITIZENSHIP RESIDENCE (City, State & Country) POST OFFICE ADDRESS (Complete Street Address including City, State & Country) DATE INVENTOR'S SIGNATURE Full Name of Seventh GIVEN NAME FAMILY NAME Inventor, if any CITIZENSHIP RESIDENCE (City, State & Country) POST OFFICE ADDRESS (Complete Street Address including City, State & Country)).± INVENTOR'S SIGNATURE DATE FAMILY NAME Full-Mame of Eighth | GIVEN NAME Inventor, if any := CITIZENSHIP RESIDENCE (City, State & Country) Ū إيا POST OFFICE ADDRESS (Complete Street Address including City, State & Country) . 7 INVENTOR'S SIGNATURE DATE FAMILY NAME Full Name of Ninth GIVEN NAME inventor, if any CITIZENSHIP RESIDENCE (City, State & Country) 4 POST OFFICE ADDRESS (Complete Street Address including City, State & Country) ľU DATE INVENTOR'S SIGNATURE FAMILY NAME Full Name of Tenth GIVEN NAME Inventor, if any CITIZENSHIP see above RESIDENCE (City, State & Country) POST OFFICE ADDRESS (Complete Street Address including City, State & Country) DATE INVENTOR'S SIGNATURE FAMILY NAME GIVEN NAME Full Name of Eleventh inventor, if any CITIZENSHIP RESIDENCE (City, State & Country) POST OFFICE ADDRESS (Complete Street Address including City, State & Country) DATE INVENTOR'S SIGNATURE **FAMILY NAME** Full Name of Twelfth GIVEN NAME Inventor, if any: CITIZENSHIP RESIDENCE (City, State & Country) POST OFFICE ADDRESS (Complete Street Address including City, State & Country)

^{*} Note: Use this sheet for applications having more than four inventors